

### **Specification**

ITEM	SPECIFICATION
SIEVE	Φ75 Exclsive sieve
DIMENSION	$W500 \times D540 \times H555 \text{ mm}$
WEIGHT	Approx 70kg
POWER	Power : AC100 ~ 240V(50/60Hz), 120w
SIEVE STEPS / RANGE OF SIEVE OPENING	8steps (Option :10setps) / 5600 $\mu$ m $\sim$ 20 $\mu$ m
SAMPLE CUP / VOLUME	1pc / 55ml
SONIC WAVE INTENSITY FREQUENCY	0 ~ 99step / 40 ~ 99Hz
TEMPERATURE RANGE	5 ~ 40°C
HUMIDITY RANGE	$20\sim85\%$ (No static electricity on the sheaves, No condensation)
EXTERNAL COMMUNICATION	USB2.0 1port (For ESC / P-R compatible printer)
	RS232C 1port (For PC or Serial printer)
TOUCH PANEL	Display size : 7inch wide, Color : 16miliion, Resolusion : 800 $ imes$ 480
BUILT-IN ELECTRONIC BALANCE	Maximum waighing : 2200g, Calibration : 2000g

- X The equipment which is mentioned in this catalog is made for general powders materials, but not for dangerous materials (poison, explosives). In the case of using it for dangerous materials, please give required process.
- % In the case of using the equipment in overseas, it is necessary to offer export country name, company name and use etc in advance. Please feel free to contact the person in charge, your kind understanding would be much appreciated.
- lepha The specification of goods and the pictures in this catalog will be changed without notice.

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inquiry

# ROBOT SIFTER RPS-01

AUTOMATED SONIC SIEVING PARTICLE SIZE ANALYZER

Ultra-high speed sieving particle size analyzer that match the needs of the times, such as data falsification prevention and automation





In June 2019, the new robot shifter RPS-01 was born. The robot control technology for accurate position control and high-speedoperation has been greatly adopted, and new functions have been added to make it easier to use.

- Speed up of Robot hand
  High speed and high accuracy operation
  compared to the old model.
- prevention function

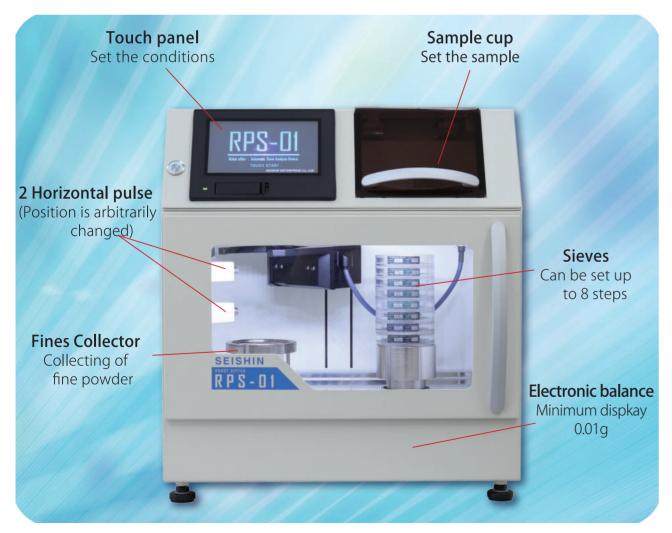
  The strangthening of the knocking mechanism improves the clogging

prevention performance of the sieve screen.

**Improved clogging** 

- Device input voltage supports AC100 to 240V.
- Sonic wave smoothing function Unique robot shifter function that suppresses sample aggregation at the start of sieving.

- Adoption of 7inch touch panel
  The screen size has been increaced, and the operability has been improved.
  - operability has been improved. Video and audio guidance function.
- In consideration of data tampering prevention
  - Supports security function of operation screen and storage of operation log data.
- Data output
  We changed printer to external connection and made it selectable according to use.
  It supports from conventional roll paper to A4 paper printer.

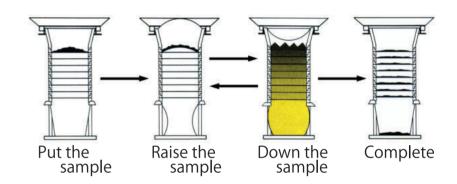


## Sonic sieving principle

By vibrating only air inside of closed sieves, sample on the sieves continues acyclic vertical movement. Sample jumps up from the sieves every half cycle and returns on the sieves next half cycle. Some of

Pulse
Pulse

the particles pass through the sieves and the others remain on the sieves. This principle minimizes abrasion of sample and sieves. For prevention of adhesion and clogging, pulses also mechanically hit on the bottom and sides of sie



### Measurement flow

